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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:

Brian Taggart et al.

§ Art Unit: 2818

Serial No.: 10/807,830

§ Examiner: Calvin Lee

Filed: March 24, 2004

§ Docket: ITL.1119US
P18791

For: Lower Profile Flexible Substrate
Package for Electronic Components

§ Assignee: Intel Corporation

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO PAPER NO. 4

Sir:

In response to the office action mailed April 18, 2005, reconsideration is requested in view of the following remarks.

Date of Deposit: June 13, 2005

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Cynthia L. Hayden
Cynthia L. Hayden